

# MBRS240LT3

## Surface Mount Schottky Power Rectifier

### SMB Power Surface Mount Package

... employing the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

- Compact Package with J-Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guardring for Overvoltage Protection
- Low Forward Voltage Drop
- Pb-Free Package is Available

#### Mechanical Characteristics:

- Case: Molded Epoxy
- Epoxy Meets UL 94, V-0 at 0.125 in
- Weight: 95 mg (approximately)
- Cathode Polarity Band
- Maximum Temperature of 260°C/10 Seconds for Soldering
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	40	V
Average Rectified Forward Current (At Rated $V_R$ , $T_C = 100^\circ\text{C}$ )	$I_O$	2.0	A
Peak Repetitive Forward Current (At Rated $V_R$ , Square Wave, 20 kHz, $T_C = 105^\circ\text{C}$ )	$I_{FRM}$	4.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	$I_{FSM}$	25	A
Storage/Operating Case Temperature	$T_{stg}, T_C$	-55 to +150	°C
Operating Junction Temperature	$T_J$	-55 to +125	°C
Voltage Rate of Change (Rated $V_R$ , $T_J = 25^\circ\text{C}$ )	dv/dt	10,000	V/ $\mu\text{s}$

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.



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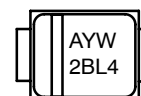
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### SCHOTTKY BARRIER RECTIFIER 2.0 AMPERES 40 VOLTS



SMB  
CASE 403A  
PLASTIC

#### MARKING DIAGRAM



2BL4 = Specific Device Code  
A = Assembly Location  
Y = Year  
W = Work Week

#### ORDERING INFORMATION

Device	Package	Shipping†
MBRS240LT3	SMB	2500/Tape & Reel
MBRS240LT3G	SMB (Pb-Free)	2500/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# MBRS240LT3

## THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance — Junction-to-Lead (Note 1)	$R_{\theta JL}$	18	$^{\circ}\text{C}/\text{W}$
Thermal Resistance — Junction-to-Ambient (Note 3)	$R_{\theta JA}$	78	$^{\circ}\text{C}/\text{W}$

## ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 2) see Figure 2 $(I_F = 2.0 \text{ A})$ $(I_F = 4.0 \text{ A})$	$V_F$	$T_J = 25^{\circ}\text{C}$	$T_J = 125^{\circ}\text{C}$	Volts
		0.43 0.54	0.375 0.55	
Maximum Instantaneous Reverse Current (Note 2) see Figure 4 $(V_R = 40 \text{ V})$ $(V_R = 20 \text{ V})$	$I_R$	$T_J = 25^{\circ}\text{C}$	$T_J = 100^{\circ}\text{C}$	mA
		2.0 0.5	60 40	

1. Mounted with minimum recommended pad size, PC Board FR4.
2. Pulse Test: Pulse Width  $\leq 250 \mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .
3. 1 inch square pad size (1 x 0.5 inch for each lead) on FR4 board.

## TYPICAL CHARACTERISTICS

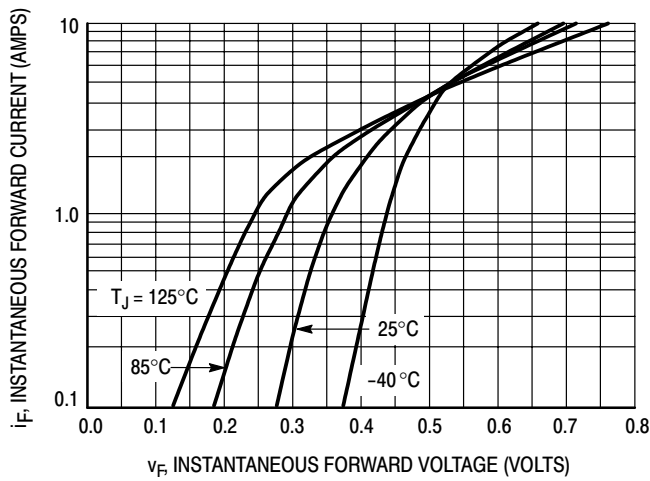


Figure 1. Typical Forward Voltage

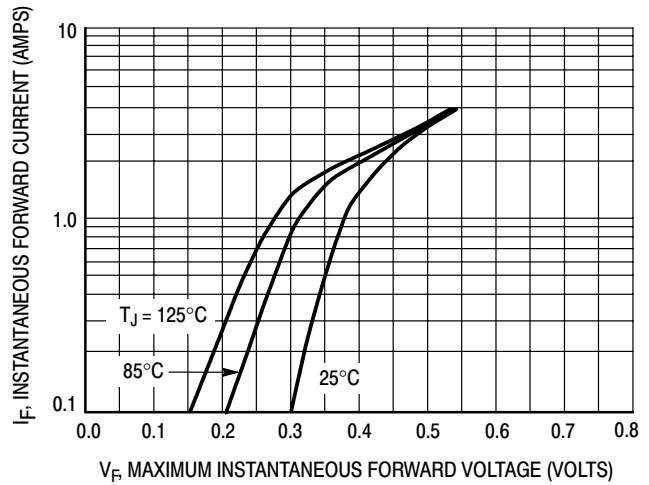


Figure 2. Maximum Forward Voltage

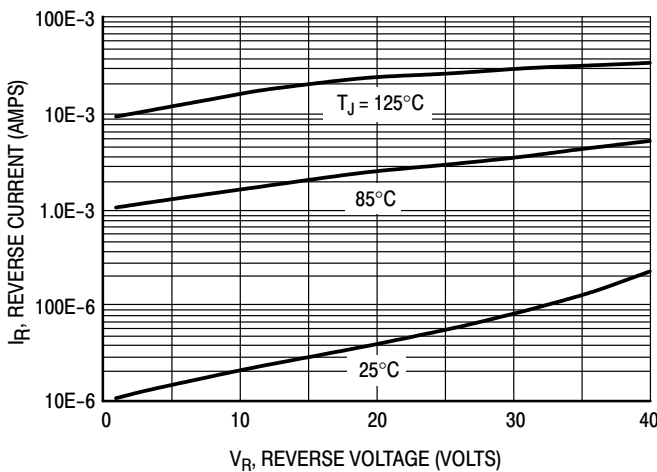


Figure 3. Typical Reverse Current

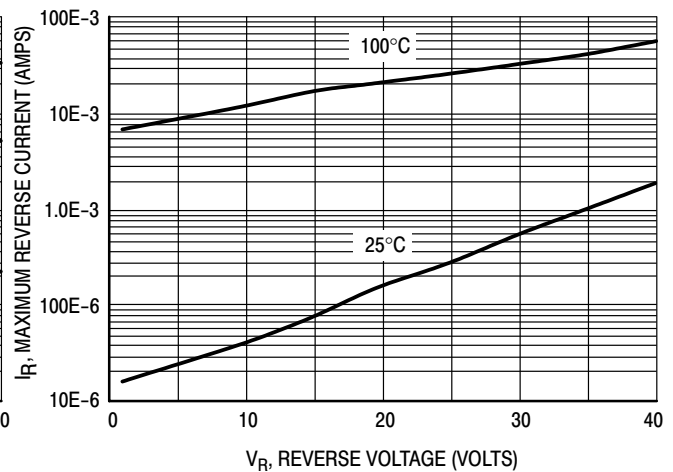


Figure 4. Maximum Reverse Current

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## TYPICAL CHARACTERISTICS

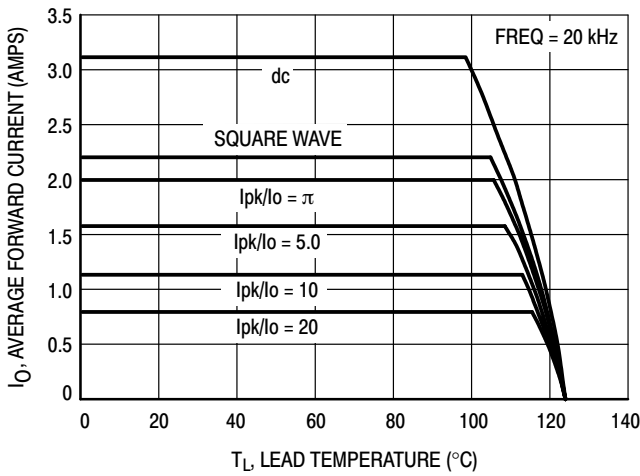


Figure 5. Current Derating

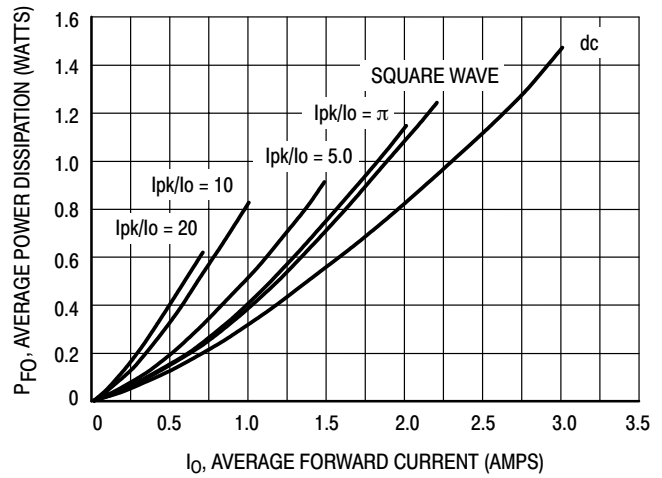


Figure 6. Forward Power Dissipation

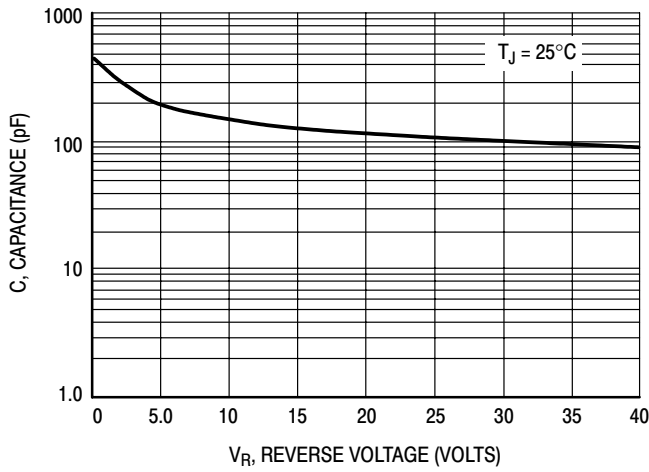


Figure 7. Capacitance

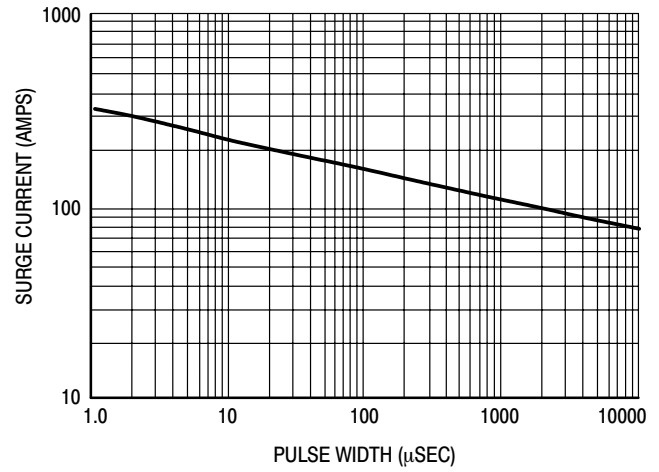


Figure 8. Maximum Non-Repetitive Forward Surge Current

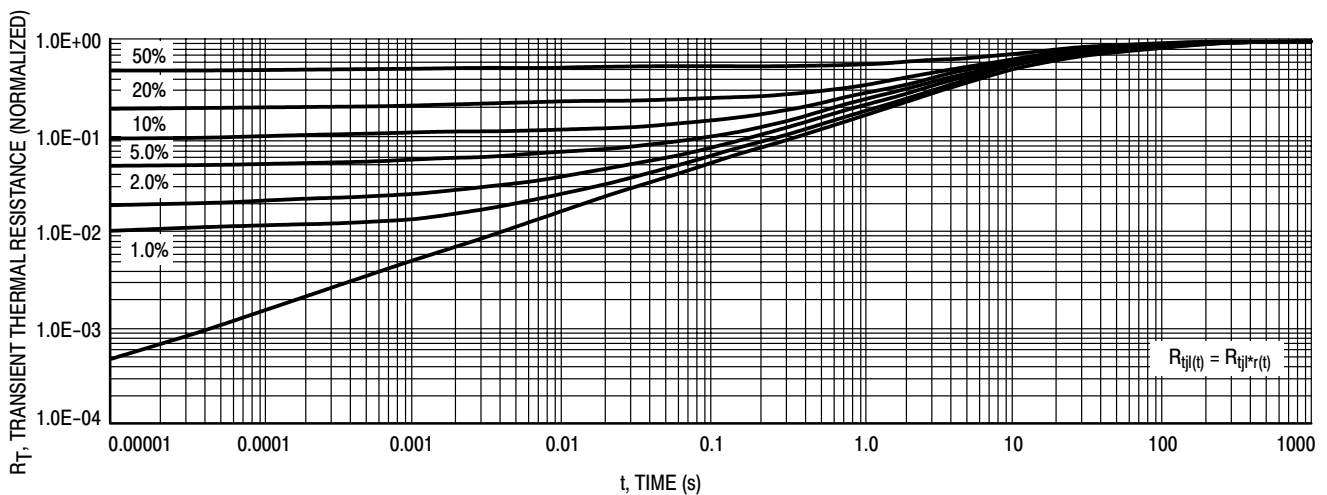
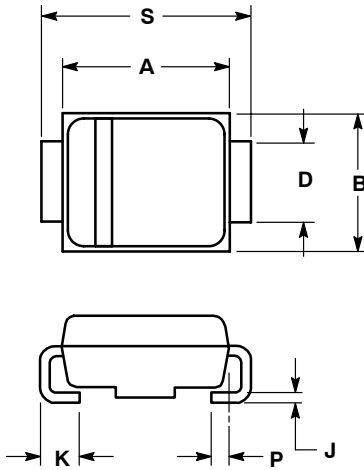


Figure 9. Thermal Response

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## PACKAGE DIMENSIONS

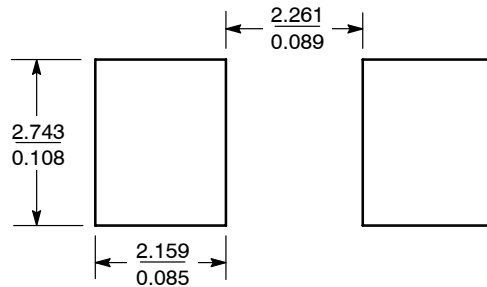
### SMB PLASTIC PACKAGE CASE 403A-03 ISSUE D



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. D DIMENSION SHALL BE MEASURED WITHIN DIMENSION P.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.160	0.180	4.06	4.57
B	0.130	0.150	3.30	3.81
C	0.075	0.095	1.90	2.41
D	0.077	0.083	1.96	2.11
H	0.0020	0.0060	0.051	0.152
J	0.006	0.012	0.15	0.30
K	0.030	0.050	0.76	1.27
P	0.020	REF	0.51	REF
S	0.205	0.220	5.21	5.59

### SOLDERING FOOTPRINT\*



SCALE 8:1  $\left(\frac{\text{mm}}{\text{inches}}\right)$

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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